



# Product Change Notification

**Change Notification #:** 114796 - 00  
**Change Title:** Intel® Xeon Phi™ Processors 7210, 7230 & 7250, PCN 114796-00, Product Design, New Product Code and Material Master Number  
**Date of Publication:** August 11, 2016

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

|   |              |
|---|--------------|
| <b>Date of Samples Availability:</b>                                    | Aug 01, 2016 |
| <b>Date of Qualification Data Availability:</b>                         | Sep 26, 2016 |
| <b>Date of First Availability of Post-Conversion Material:</b>          | Sep 26, 2016 |
| <b>Date Customer Must be Ready to Receive Post-Conversion Material:</b> | Nov 28, 2016 |

*The date of "First Availability of Post-Conversion Material" is the projected date that a customer may expect to receive the Post-Conversion Materials. This date is determined by the projected depletion of inventory at the time of the PCN publication. The depletion of inventory may be impacted by fluctuating supply and demand, therefore, although customers should be prepared to receive the Post-Converted Materials on this date, Intel will continue to ship and customers may continue to receive the pre-converted materials until the inventory has been depleted.*

## Description of Change to the Customer:

A new product code and material master number (MM#) will be replacing Intel® Xeon Phi™ Processors 7210, 7230 & 7250. Please see the Products Affected/Intel Ordering Codes table below for more information.

## Customer Impact of Change and Recommended Action:

Intel anticipates no change or impact to customer platforms designed to Intel guidelines. However, new post-conversion material master numbers (MM#s) and S-specs will be replacing the pre-conversion product data listed in the Products Affected/Intel Ordering Codes table.

Customers should be ready to receive the new material by the "Date Customer Must be Ready to Receive New Material" as shown above in the milestones above. Moreover, pre-conversion products will not be available to customers after the "Date Customer Must be Ready to Receive New Material" date listed in this Product Change Notification, except upon specific customer requests to drain existing inventory (where both excess supply exists and Intel Field Sales Representative agrees).

If Post-converted material is available any sooner than the date given for "Date of First Availability of Post-Conversion Material" customers may be able to start receiving it. Please contact your Intel Field Sales Representative for any questions, requests or concerns.

## Products Affected / Intel Ordering Codes:

| Intel ® Xeon Phi™ Processors |           |        |        |            |                 |                 |        |            |
|------------------------------|-----------|--------|--------|------------|-----------------|-----------------|--------|------------|
| Pre Conversion               |           |        |        |            | Post Conversion |                 |        |            |
| Product Code                 | Processor | S-Spec | MM#    | Step / Rev | MM#             | Product Code    | S-Spec | Step / Rev |
| HJ8066702859200              | 7250      | S R2MD | 947605 | B-0        | 951266          | HJ8066702859200 | S R2X1 | B-0        |
| HJ8066702859300              | 7210      | S R2ME | 947607 | B-0        | 951272          | HJ8066702859300 | S R2X4 | B-0        |
| HJ8066702859400              | 7230      | S R2MF | 947609 | B-0        | 951270          | HJ8066702859400 | S R2X3 | B-0        |

## PCN Revision History:

**Date of Revision:**

August 11, 2016

**Revision Number:**

00

**Reason:**

Originally Published PCN



# Product Change Notification

## 114796 - 00

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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